VS-GB50NA120UX

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"High Side Chopper" IGBT SOT-227 (Ultrafast IGBT), 50 A



SOT-227

PRODUCT SUMMARY							
V _{CES}	1200 V						
I _C DC	50 A at 92 °C						
V _{CE(on)} typical at 50 A, 25 °C	3.22 V						
Speed	8 kHz to 30 kHz						
Package	SOT-227						
Circuit	High side switch						

FEATURES

- NPT Gen 5 IGBT technology
- Square RBSOA
- HEXFRED[®] clamping diode
- Positive V_{CE(on)} temperature coefficient
- · Fully isolated package
- Very low internal inductance (≤ 5 nH typical)
- Industry standard outline
- UL approved file E78996
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- · Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- · Direct mounting on heatsink
- · Plug-in compatible with other SOT-227 packages
- · Low EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Collector to emitter voltage	V _{CES}		1200	V		
Continuous collector current	1-	T _C = 25 °C	84			
	I _C	T _C = 80 °C	57			
Pulsed collector current	I _{CM}		150	А		
Clamped inductive load current	I _{LM}		150	A		
Diode continuous forward current	١ _F	T _C = 25 °C	76			
		T _C = 80 °C	52			
Gate to emitter voltage	V _{GE}		± 20	V		
Power dissipation, IGBT	Б	T _C = 25 °C	431			
	P _D	T _C = 80 °C	242	W		
	P _D	T _C = 25 °C	278	vv		
Power dissipation, diode		T _C = 80 °C	156			
RMS isolation voltage	V _{ISOL}	V _{ISOL} Any terminal to case, t = 1 min 2500		V		



COMPLIANT



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 V, I_C = 1 mA$	1200	-	-			
		V _{GE} = 15 V, I _C = 25 A	-	2.46	-			
	N	V _{GE} = 15 V, I _C = 50 A -		3.22	2.80	v		
Collector to emitter voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 25 A, T _J = 125 °C	-	2.84	3.60			
		V_{GE} = 15 V, I _C = 50 A, T _J = 125 °C	-	3.78	3.0			
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 500 \ \mu A$	4	5	4	1		
Temperature coefficient of threshold voltage	$V_{GE(th)}/\Delta T_J$	V_{CE} = V_{GE} , I_C = 1 mA (25 °C to 125 °C)	-	-10	-	mV/°C		
Collector to emitter leakage current		V _{GE} = 0 V, V _{CE} = 1200 V	-	6	50	μA		
	I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 1200 \text{ V}, \text{T}_{\text{J}} = 125 ^{\circ}\text{C}$	-	0.7	2.0	mA		
Diode reverse breakdown voltage	V _{BR}	I _R = 1 mA	1200	-	-	V		
		I _C = 25 A, V _{GE} = 0 V	-	1.99	2.42			
Diada famuard valtaga dran	V _{FM}	$I_{C} = 50 \text{ A}, V_{GE} = 0 \text{ V}$ -		2.53	3.00	V		
Diode forward voltage drop		$I_{C} = 25 \text{ A}, V_{GE} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	1.96	2.30	v		
		$I_{C} = 50 \text{ A}, V_{GE} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	2.66	3.08			
		$V_{R} = V_{R}$ rated	-	4	50	μA		
Diode reverse leakage current	I _{RM}	$T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$	-	0.6	3	mA		
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 200	nA		

PARAMETER	SYMBOL	TEST CONDIT	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Qg			-	400	-	
Gate to emitter charge (turn-on)	Q _{ge}	$I_{\rm C} = 50$ A, $V_{\rm CC} = 600$ V, V	/ _{GE} = 15 V	-	43	-	nC
Gate to collector charge (turn-on)	Q _{gc}		-	187	-		
Turn-on switching loss	E _{on}	$I_{\rm C} = 50$ A, $V_{\rm CC} = 600$ V,	-	-	2.72	-	mJ
Turn-off switching loss	E _{off}	$V_{GE} = 15 \text{ V}, \text{ R}_{g} = 5 \Omega,$		-	1.11	-	
Total switching loss	E _{tot}	L = 500 µH, T _J = 25 °C		-	3.83	-	
Turn-on switching loss	E _{on}		Energy losses include tail and diode recovery (see fig. 18)	-	3.94	-	
Turn-off switching loss	E _{off}			-	2.31	-	
Total switching loss	E _{tot}	I _C = 50 A, V _{CC} = 600 V,		-	6.25	-	
Turn-on delay time	t _{d(on)}	$V_{GE} = 15 \text{ V}, \text{ R}_{g} = 5 \Omega,$		-	191	-	ns
Rise time	t _r	L = 500 µH, T _J = 125 °C		-	53	-	
Turn-off delay time	t _{d(off)}			-	223	-	
Fall time	t _f			-	143	-	
Reverse bias safe operating area	RBSOA	$\begin{split} T_{J} &= 150 \ ^{\circ}\text{C}, \ I_{C} &= 150 \ \text{A}, \\ V_{GE} &= 15 \ \text{V to } 0 \ \text{V}, \ V_{CC} &= \\ V_{P} &= 1200 \ \text{V} \end{split}$		Fullsquare			
Diode reverse recovery time	t _{rr}			-	129	161	ns
Diode peak reverse current	l _{rr}	$I_F = 50 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/1000 $	$I_F = 50 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 200 \text{ V}$				А
Diode recovery charge	Q _{rr}	-				1046	nC
Diode reverse recovery time	t _{rr}		,	-	208	257	ns
Diode peak reverse current	I _{rr}	I _F = 50 A, dI _F /dt = 200 A/ V _B = 200 V, T _J = 125 °C	μs,	-	17	21	А
Diode recovery charge	Q _{rr}	$v_{\rm R} = 200 v, 1j = 125 C$	-	1768	2698	nC	

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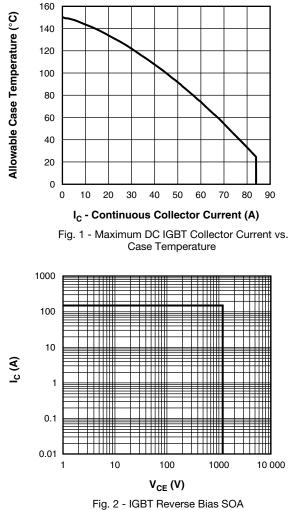
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THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL		MIN.	TYP.	MAX.	UNITS
Junction and storage temperature	range	T _J , T _{Stg}		-40	-	150	°C
Junction to case	IGBT			-	-	0.29	
Junction to case	Diode	- R _{thJC}		-	-	0.45	°C/W
Case to heatsink		R _{thCS}	Flat, greased surface	-	0.05	-	
Weight				-	30	-	g
Mounting torque				-	-	1.3	Nm
Case style		SOT-227					



T_J = 150 °C, V_{GE} = 15 V

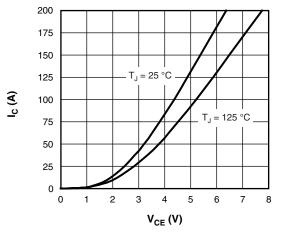


Fig. 3 - Typical IGBT Collector Current Characteristics

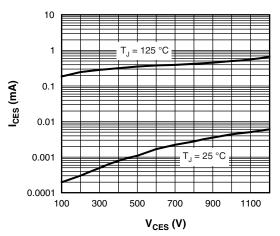
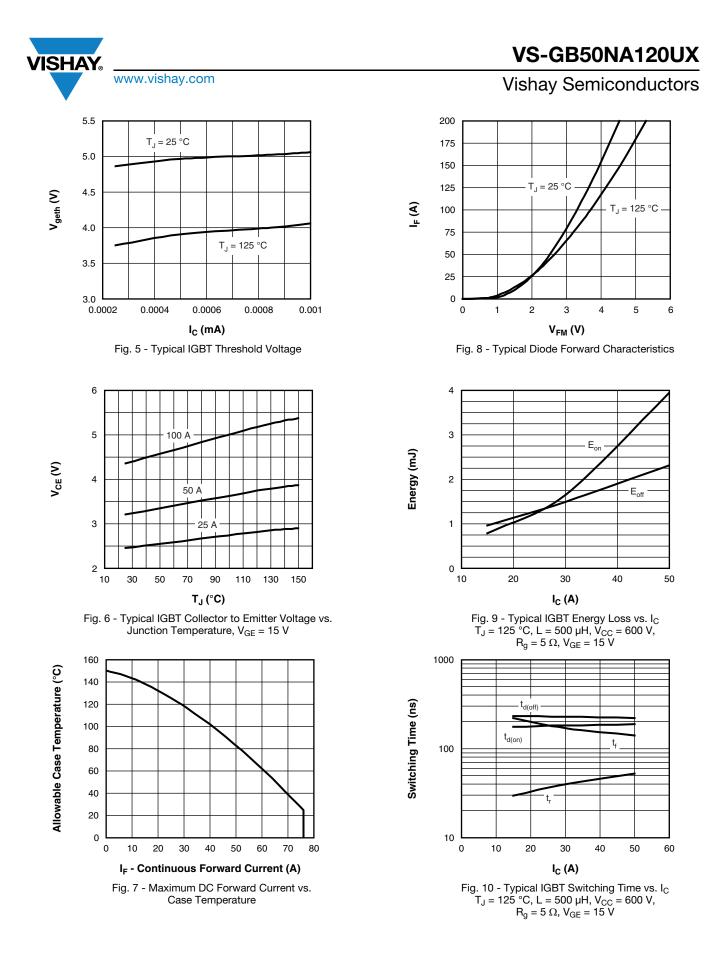


Fig. 4 - Typical IGBT Zero Gate Voltage Collector Current

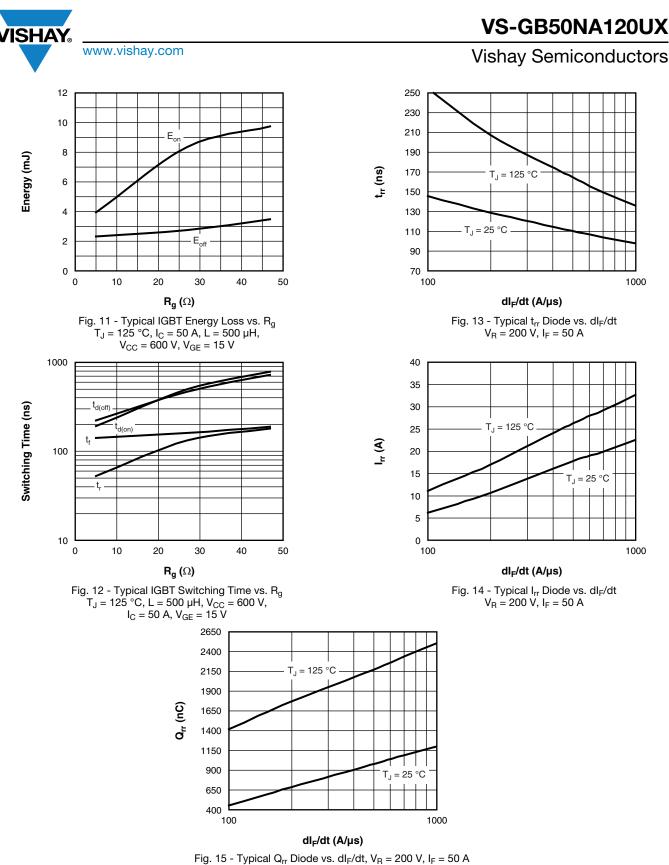


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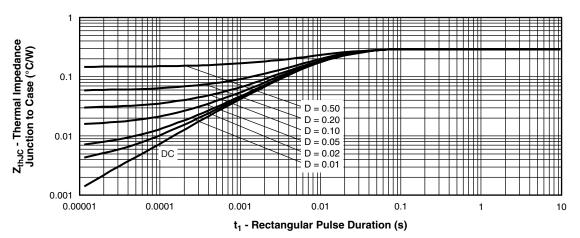
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Fig. 16 - Maximum Thermal Impedance ZthJC Characteristics (IGBT)

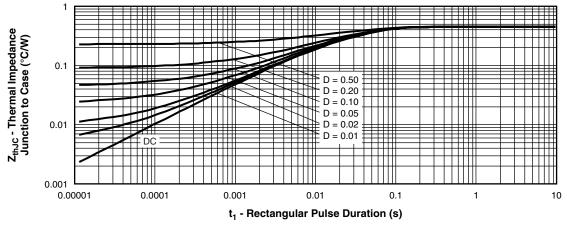
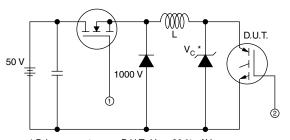


Fig. 17 - Maximum Thermal Impedance Z_{thJC} Characteristics (Diode)



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Driver same type as D.U.T.; V_C = 80 % of V_{ce(max)}
 Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain Id

Fig. 18a - Clamped Inductive Load Test Circuit

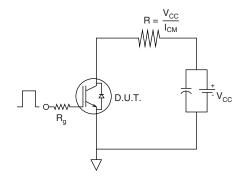


Fig. 18b - Pulsed Collector Current Test Circuit

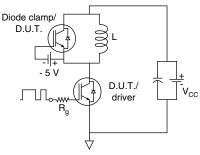


Fig. 19a - Switching Loss Test Circuit

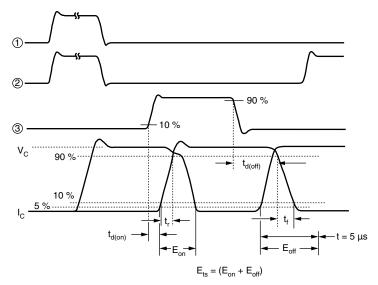


Fig. 19b - Switching Loss Waveforms Test Circuit

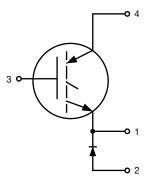
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ORDERING INFORMATION TABLE

Device code	VS-	G	В	50	N	Α	120	U	x
	1	2	3	4	5	6	7	8	9
	1 - 2 -	 Insulated Gate Bipolar Transistor (IGBT) 							
	3 - 4 -								
	5 -	Circ	Circuit configuration (N = High side chopper)						
	6 -	Pac	Package indicator (A = SOT-227)						
	7 -	Volt	Voltage rating (120 = 1200 V)						
	8 -	Spe	Speed/type (U = Ultrafast IGBT)						
	9 -	X =	X = F/W HEXFRED [®] diode						

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS						
Dimensions	www.vishay.com/doc?95036					
Packaging information	www.vishay.com/doc?95037					

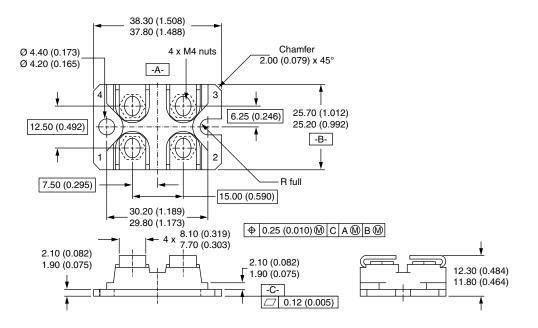


Outline Dimensions

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DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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